



[10191/3081]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) : GOMEZ et al. Confirmation No.: 7307
Serial No. : 10/618,795
Filed : July 14, 2003
Title : MICROSTRUCTURED COMPONENT AND
METHOD FOR ITS MANUFACTURE
Art Unit : 1772
Examiner : D. Loney
Customer No. : 26646

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AMENDMENT

SIR:

In response to the Office Action dated April 18, 2006, please amend the
above-referenced application as set forth below.

Amendments to the Specification do not appear in this paper.

Amendments to the Claims are reflected in the listing of the claims which begins on page 2
of this paper.

Amendments to the Drawings do not appear in this paper.

Remarks begin on page 4 of this paper.